



## Product/Process Change Notice - PCN 23\_0095 Rev. -

Analog Devices, Inc. One Analog Way, Wilmington, MA 01887, USA

This notice is to inform you of a change that will be made to certain ADI products (see Appendix A) that you may have purchased in the last 2 years. **Any inquiries or requests with this PCN (additional data or samples) must be sent to ADI within 30 days of publication date.** ADI contact information is listed below.

<b>PCN Title:</b>	Qualification of an Alternate Adhesive Material and Molding Compound for Select LFCSP Packages
<b>Publication Date:</b>	16-Jun-2023
<b>Effectivity Date:</b>	18-Sep-2023 <i>(the earliest date that a customer could expect to receive changed material)</i>
<b>Revision Description:</b>	Initial Release

### Description Of Change:

Qualification of an alternate adhesive material and molding compound for select LFCSP packages (LFCSP with non-conductive epoxy).

1. Adhesive material: Hitachi EN4300
2. Mold compound: Sumitomo G700LA.

### Reason For Change:

Additional adhesive material and molding compound for increased capability.

### Impact of the change (positive or negative) on fit, form, function & reliability:

The devices' fit, form, function and reliability as specified by the Product Data Sheet will be unaffected by these changes. The package outline dimension and lead footprint dimension will remain the same for LFCSP packages.

### Product Identification *(this section will describe how to identify the changed material)*

Date Code and Lot number will be used for product identification.

### Summary of Supporting Information:

Qualification has been performed per Industry Standard Test Methods. See attached Qualification Results Summary.

### Supporting Documents

**Attachment 1: Type:** Detailed Change Description

[ADI\\_PCN\\_23\\_0095\\_Rev - Detailed Change Description.pdf...](#)

**Attachment 2: Type:** Qualification Results Summary

[ADI\\_PCN\\_23\\_0095\\_Rev - ADG5207 Qualification Report.pdf...](#)

Note: If applicable, the device material declaration will be updated due to material change.

### ADI Contact Information:

For questions on this PCN, please send an email to the regional contacts below or contact your local ADI sales representatives.

<b>Americas:</b>	<b>Europe:</b>	<b>Japan:</b>	<b>Rest of Asia:</b>
PCN_Americas@analog.com	PCN_Europe@analog.com	PCN_Japan@analog.com	PCN_ROA@analog.com

## Appendix A - Affected ADI Models:

### Added Parts On This Revision - Product Family / Model Number (18)

AD590 / AD590JCPZ-R5	AD590 / AD590JCPZ-RL7	ADG5204 / ADG5204BCPZ-RL7	ADG5206 / ADG5206BCPZ-RL7	ADG5207 / ADG5207BCPZ-RL7
ADG5208 / ADG5208BCPZ-RL7	ADG5209 / ADG5209BCPZ-RL7	ADG5212 / ADG5212BCPZ-RL7	ADG5213 / ADG5213BCPZ-RL7	ADG5233 / ADG5233BCPZ-RL7
ADG5234 / ADG5234BCPZ-RL7	ADG5236 / ADG5236BCPZ-RL7	ADG5404 / ADG5404BCPZ-REEL7	ADG5408 / ADG5408BCPZ-REEL7	ADG5409 / ADG5409BCPZ-REEL7
ADG5413 / ADG5413BCPZ-REEL7	ADG5433 / ADG5433BCPZ-REEL7	ADG5436 / ADG5436BCPZ-REEL7		

**Appendix B - Revision History:**

<b>Rev</b>	<b>Publish Date</b>	<b>Effectivity Date</b>	<b>Rev Description</b>
Rev. -	16-Jun-2023	18-Sep-2023	Initial Release